

# Product Change Notice



**PCN:** PCN\_KVR24R17S4\_8I\_C1  
**Date:** July 1, 2016

**Kingston Technology Company**  
17600 Newhope Street  
Fountain Valley, CA 92708  
USA

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**Type of Change:** Build (BOM) Phase Out for End of Life

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**Product(s) Affected:** KVR24R17S4/8I  
KVR24R17S4K4/32I (Kit of 4)

**Qualified Build:** 9965589-017.D00G (Hynix A Die) – Phase Out  
9965589-031.D01G (Micron B Die) – Qualifying, ETA 8/1/16

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**Product Description:** 8GB DDR4-2400 Registered DIMM CL17 1Rx4 1.2V Intel Certified

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**Description of Change:** Build 9965589-017.D00G using Hynix A Die is being phased out and replaced by a next generation DRAM component. Alternate build 9965589-031.D01G using Micron B Die is being qualified and is estimated to be available on 8/1/2016.

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**Target EOL Date:** September 29, 2016

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